

DATA SHEET

ARRAY CHIP RESISTORS

YC248 (16Pin/8R)

5%, 1% sizes 0616

RoHS compliant



YAGEO Phicomp



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SCOPE

This specification describes YC248 series chip resistor arrays with lead-free terminations made by thick film process.

APPLICATIONS

- Terminal for SDRAM and **DDRAM**
- Computer applications: laptop computer, desktop computer
- Consume electronic equipment: PDAs, PNDs
- Mobile phone, telecom...

FEATURES

- RoHS compliant
 - Products with lead free terminations meet RoHS requirements
 - Pb-glass contained in electrodes
 - Resistor element and glass are exempted by RoHS
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production
- Halogen Free Epoxy

ORDERING INFORMATION - GLOBAL PART NUMBER

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

YC248 - X X X XX XXXX L

(1) (2) (3) (4)

(I) TOLERANCE

 $F = \pm 1\%$

 $J = \pm 5\%$ (for Jumper ordering, use code of J)

(2) PACKAGING TYPE

R = Paper taping reel

K = Embossed taping reel

(3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(4) TAPING REEL

07 = 7 inch dia, Reel

(5) RESISTANCE VALUE

There are 2~4 digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

Evample

(6) OPTIONAL CODE

Resistance code rule

L = optional symbol (Note)

Resistance rule of global part number

Resistance code ru	ie Example
OR	0R = Jumper
XRXX (1 to 9.76 Ω)	$ R = \Omega$ $ R5 = .5 \Omega$ $9R76 = 9.76 \Omega$
XXRX (10 to 97.6 Ω)	$10R = 10 \Omega$ $97R6 = 97.6 \Omega$
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX (1 to 9.76 KΩ)	IK = I,000 Ω 9K76 = 9760 Ω
XMXX (1 to 9.76 MΩ)	IM = 1,000,000 Ω 9M76 = 9,760,000 Ω

ORDERING EXAMPLE

The ordering code of a YC248 convex chip resistor array, value $1,000 \Omega$ with $\pm 5\%$ tolerance, supplied in 7-inch tape reel is: YC248-JR-071K(L).

NOTE

- I. All our RSMD products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER



PHYCOMP BRAND ordering codes

Both GLOBAL PART NUMBER (preferred) and I2NC (traditional) codes are acceptable to order Phycomp brand products.

GLOBAL PART NUMBER (PREFERRED)

For detailed information of GLOBAL PART NUMBER and ordering example, please refer to page 2.

I2NC CODE 2250

235	U	$\Delta \Delta \Delta$	XXXXX L	
(1)		(2) (3) (4)	
TYPE/		TOL.	RESISTANCE	PAPER / PE TAPE ON REEL (units) (2)
0616	IN ⁽¹⁾	(%)	RANGE	5,000
ARV381	2350	±5%	10 to 1 $M\Omega$	053 I0xxx
ARV382	2350	±1%	10 to 1 $M\Omega$	043 Ixxxx
Jumper	2350	-	0 Ω	053 91001

- (1) The resistors have a 12-digit ordering code starting with 2350.
- (2) The subsequent 4 or 5 digits indicate the resistor tolerance and packaging.
- (3) The remaining 4 or 3 digits represent the resistance value with the last digit indicating the multiplier as shown in the table of "Last digit of I2NC".
- (4) "L" is optional symbol (Note).

ORDERING EXAMPLE

The ordering code of a ARV381 resistor, value 1,000 Ω with ±5% tolerance, supplied in tape of 5,000 units per reel is: 235005310102(L) or YC248-JR-071K(L).

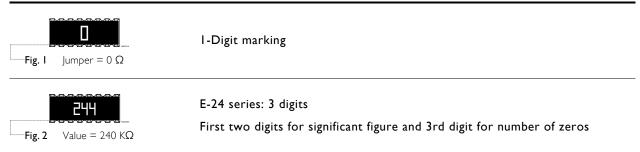
Last digit of 12NC	
Resistance decade ⁽³⁾	Last digi
0.01 to 0.0976 Ω	(
0.1 to 0.976 Ω	7
I to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
I to 9.76 KΩ	2
10 to 97.6 KΩ	3
100 to 976 KΩ	4
I to 9.76 MΩ	5
10 to 97.6 MΩ	ϵ

Example:	0.02 Ω	=	0200 or 200
	0.3 Ω	=	3007 or 307
	ΙΩ	=	1008 or 108
	33 KΩ	=	3303 or 333
	10 MΩ	=	1006 or 106

- I. All our RSMD products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / I2NC can be added (both are on customer request)

MARKING

YC248

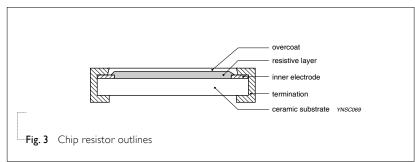


For further marking information, please see special data sheet "Chip resistors marking"

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy

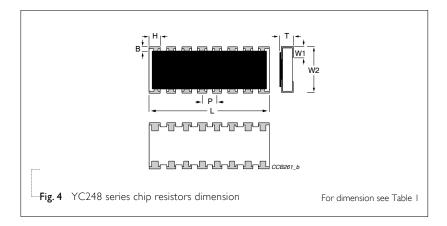
OUTLINES



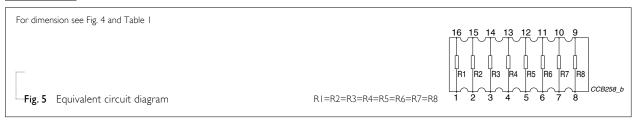
coat, finally the two external terminations (matte tin on Ni-barrier) are added. See fig.3

DIMENSIONS

Table I	
TYPE	YC248
B (mm)	0.30 ±0.15
H (mm)	0.45 ±0.05
P (mm)	0.50 ±0.05
L (mm)	4.00 ±0.20
T (mm)	0.45 ±0.10
W _I (mm)	0.40 ±0.15
W ₂ (mm)	1.60 ±0.15



SCHEMATIC



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ELECTRICAL CHARACTERISTICS

Table 2

CHARACTERISTICS	YC248 I/16 W		
Operating Temperature Range	–55 °C to +155 °C		
Maximum Working Voltage		50 V	
Maximum Overload Voltage		100 V	
Dielectric Withstanding Voltage	100 V		
Number of Resistors		8	
	5% (E24)	$10~\Omega$ to $1~M\Omega$	
Resistance Range	1% (E24/E96)	10 Ω to 1 M Ω	
	Zero Ohm Jumper	< 0.05 Ω	
Temperature Coefficient		±200 ppm/°C	
Jumper Criteria	Rated Current	2.0 A	
	Maximum Current	10 A	

FOOTPRINT AND SOLDERING **PROFILES**

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
YC248	Paper Taping Reel (R)	7" (178 mm)	5,000 units
	Embossed taping reel (K)	7" (178 mm)	4,000 units

NOTE

1. For Paper/Embossed tape and reel specification/dimensions, please see the special data sheet "Chip resistors packing".

FUNCTIONAL DESCRIPTION

POWER RATING

YC 248 rated power at 70 °C is I/I6 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

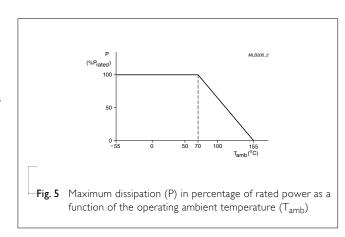
or max. working voltage whichever is less

Where

V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value (Ω)



TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/ Operational Life/ Endurance	MIL-STD-202G-method 108A IEC 60115-1 4.25.1 JIS C 5202-7.10	1,000 hours at 70±5 °C applied RCWV 1.5 hours on, 0.5 hour off, still air required	±(2%+0.05 Ω)
High Temperature Exposure/ Endurance at upper category temperature	MIL-STD-202G-method 108A IEC 60115-1 4.25.3 JIS C 5202-7.11	I,000 hours at maximum operating temperature depending on specification, unpowered No direct impingement of forced air to the parts Tolerances: I55±3 °C	±(1%+0.05 Ω)
Moisture Resistance	MIL-STD-202G-method 106F IEC 60115-1 4.24.2	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	±(2%+0.05 Ω)
		Parts mounted on test-boards, without condensation on parts	
		Measurement at 24±2 hours after test conclusion	
Thermal Shock	MIL-STD-202G-method 107G	-55/+155 °C Note: Number of cycles required is 300. Devices unmounted	$\pm (0.5\% + 0.05 \ \Omega)$ for 10 K Ω to 10 M Ω $\pm (1\% + 0.05 \ \Omega)$ for others
		Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	±(1/6 · 6/65 ±2) for outers
Short time overload	MIL-R-55342D-para 4.7.5 IEC60115-1 4.13	2.5 times RCWV or maximum overload voltage whichever is less for 5 sec at room temperature	$\pm (2\% + 0.05 \ \Omega)$ No visible damage
Board Flex/ Bending	IEC60115-1 4.33	Device mounted on PCB test board as described, only I board bending required 3 mm bending	±(1%+0.05 Ω) No visible damage
		Bending time: 60±5 seconds Ohmic value checked during bending	

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	IPC/JEDECJ-STD-002B test B IEC 60068-2-58	Electrical Test not required Magnification 50X SMD conditions: Ist step: method B, aging 4 hours at 155 °C dry heat 2nd step: leadfree solder bath at 245±3 °C Dipping time: 3±0.5 seconds	Well tinned (≥95% covered) No visible damage
- Leaching	IPC/JEDECJ-STD-002B test D IEC 60068-2-58	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
- Resistance to Soldering Heat	MIL-STD-202G-method 210F IEC 60068-2-58	Condition B, no pre-heat of samples Leadfree solder, 270 °C, 10 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	±(1%+0.05 Ω) No visible damage

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Oct 31, 2008	-	- Change to dual brand datasheet that describes YC248 with RoHS compliant
			- Description of "Halogen Free Epoxy" added
			- Define global part number
Version I	Feb 22, 2005	-	- New datasheet for 0616 (16Pin/8R) chip resistor arrays 1% and 5% with lead-free terminations
			- Replace the 0616 part of pdf files: ARV381_5_3.pdf and ARV382_1_4.pdf
			- Test method and procedure updated
Version 0	Nov. 10, 2003	-	- First issue of this specification

[&]quot;Yageo reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."